ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannocl nternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level par	rts, the	declaratio	n encom		ver level mate	erials for	which t	e item is an assembly he manufacturer has declaration.
1752-2 1.1	ard	Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa									
Supplier Information														
Company Name *		Company Unique ID		Unique ID Au	uthority	Respon	se Date	• *	F	Response Do	cument ID			
SEMTECH CORP. (CPMGR01						2011-08	8-08							
Contact Name * Title - Contact			Phone - Cor	Email -	Contac	t *			a	A (1				
ROYA READER			805-389-274	Rreader@semtech.com			ו ו	Duplicat	e Contact ·	 Author 	rized R	epresentative		
Authorized Representative * Title - Representative			9	Phone - Rep	Email - Representative *			* 5	Supplier Comments or URL for Additional Information					
ROYA READER				805-389-274	2	Rreade	r@semt	ech.com	n					
Requester Item Numbe	r	Mfr Item Number		Mfr Item Name	Effective	Effective Date Version			cturing Site	Weight *	UC	M	Unit Type	
RCLAMP0854P.TCT		RCLAMP0854P.TCT		Rail Clamp L	ow Capacitance T	V			China		4.245	mg		Each
Alternate Recommenda	Alternate Recommendation							Alternate Item Co		omments				
Manufacturing Proces	ss In	formation												
Terminal Plating / Grid Array	Materi	ial	Terminal B	ase Alloy	J-STD-020 MSL Ra	ating P	eak Proc	ess Body	Tempera	ature Max Tim	e at Peak Tem	perature	Number	of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au) CU Alloy Comments			1	-	260			C 30 seco				-		
RClamp0854P.TCT is RE	ACH	-compliant product,	per EU R	egulation EC	C1907/2006 to incl	ude rece	ent addi	ition of S	SVHC ca	andidate list	of substance	es in Ju	ne 2011	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields						
RoHS Materia	RoHS Material Composition Declaration Declaration Type * Detailed												
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),						
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided						
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted						
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration						
Declaration S	ignature												
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se	• • • • •	and the second s	terrestring and - Distingthe stars						

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem				Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight		Toleran	ance	PPM
		Name			Material	weight	Measure			Level	Substance Category			Substance		Lvempt	weight	Measure	-	+	
+I	-1	Die	+M	-м	Doped Silicon	0.1612	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.1612	mg			37,965
+I	-1	Leadframe	+M	М-	C7025	1.4963	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		1.435	mg			337,99
					-	•						+S	-s	Si	7440-21-3		0.0108	mg			2,555
								+C	-C	в		+S	-s	Nickel	7440-02-0		0.0479	mg			11,278
								+C	-C	Supplier		+S	-s	Mg	7439-95-4		0.0026	mg			617
			+M	-м	Ni/Pd/Au Lead F	i0.0384	mg	+C	-C	в		+S	-s	Nickel	7440-02-0		0.0346	mg			8,149
								+C	-C	Supplier	Middle Plating	+S	-s	Pd	7440-05-3		0.0031	mg			741
								+C	-C	Supplier	Outer Plating	+S	-s	Au	7440-57-5		0.00069	mg			147
+I	-1	Bonding Wire	+M	М-	Gold	0.047	mg	+C	-C	Supplier		+S	-S	Au	7440-57-5		0.047	mg			11,063
+I	-1	Molding Compound	+M	М-	EME-G770HCD	2.4256	mg	+C	-C	Supplier		+S	-S	Silica fused	60676-86-0		2.268	mg			534,20
												+S	-s	Epoxy resin	Proprietary		0.0728	mg			17,140
												+S	-s	Phenol resin	Proprietary		0.0728	mg			17,140
												+S	-s	Carbon Black	1333-86-4		0.0121	mg			2,857
+I	-1	Die attached Epoxy	+M	М-	QMI519	0.077	mg	+C	-C	Supplier		+S	-S	Ag	7440-22-4		0.0616	mg			14,517
												+S	-s	Palladium compound	Proprietary		0.0001	mg			27
												+S	-s	2,6-Di-tert-butyl-p-creso	128-37-0		0.000003	mg			1
												+S	-s	Hydroquinone	123-31-9		0.00000	lmg			0
												+S	-s	Acrylate	Proprietary		0.0122	mg			2,875
												+S	-s	Bismaleimide resin	Proprietary		0.0023	mg			544
												+S	-s	Polymer of polybutadie	Proprietary		0.0008	mg			181